

# CEMIMAX A2000E

## Conductive Universal Adhesive

### Description:

Dispersion adhesive for resilient synthetic floor and wall coverings in interior areas. for universal use. the premium conductive universal adhesive product.

### Especially suitable for:

- For conductive PVC and flooring up to 4 mm thickness for universal use. the premium conductive uni-versal adhesive product.
- For conductive textile floor coverings
- on absorbent and levelled substrates
- on dense, non-absorbent substrates
- For exposure to castor wheels in accordance with DIN EN 12 529
- Suitable for warm water underfloor heating

### Product Properties:

- Stable quality Bonding, layer has durable resilience.
- Good water resistance, excellent bonding strength.
- Very high initial tack and final bonding strength.
- Easy application, high coverage rate.
- Low VOC

### Binders:

Modified polyacrylate-copolymers with bond strengthening resins.

### Technical Data: ( Under normal conditions at 20°C.)

**Packaging:** 20kg Plastic

**Shelf-life:** Min. 12 months

**Colour:** Cream-white

**Working temperature:** +5°C - 35°C

**Consumption:** 3.75m<sup>2</sup>/1 Litres

**Open time:** 5-30 minutes

**Working time:** 1-2 hours

**Set to traffic:** After 24-48 hours

**Final strength:** After 5-7 days

### Application:

- Allow primers and smoothing compounds to dry thoroughly. Refer to the product Data Sheet for the products used.

- Stir thoroughly the product before use, Apply it evenly on the surface of substrate by using A2 or A3 toothed trowel. After short open time of 5-30 min. the substrate is ready to accept above flooring material.
- After the flooring material is applied on the substrate rub the surface by wood plate or roll by roller to remove entranced air under the flooring material. Make sure that the adhesive has transferred to the back of the flooring material.
- The adhesive will be dried after 24h, and set to foot traffic after 48h.

### Notes:

The product should be protected against frost and direct light during transportation, storage and application. Application temperature should not be lower than 5°C.

